

MICRO-OPTICS

INFRARED SOURCES

MASS FLOW DEVICES

LASER GAS DETECTION

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EMIRS50 AT06V BT170

Thermal MEMS based infrared source

For direct electrical fast modulation

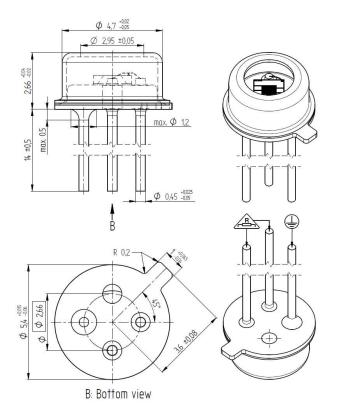
Base version, TO46 with standard Cap

■ Infrared Source

Axetris infrared (IR) sources are micro-machined, electrically modulated thermal infrared emitters featuring true blackbody radiation characteristics, low power consumption, high emissivity and a long lifetime. The appropriate design is based on a resistive heating element deposited onto a thin dielectric membrane which is suspended on a micro-machined silicon structure.

■ Infrared Gas Detection Applications

- Measurement principles: non-dispersive infrared spectroscopy (NDIR), photoacoustic infrared spectroscopy (PAS) or attenuated-total-reflectance FTIR spectroscopy (ATR)
- Target gases: CO, CO₂, VOC, NO_X, NH₃, SO_X, SF₆, hydrocarbons, humidity, anesthetic agents, refrigerants, breath alcohols
- Medical: Capnography, anesthesia gas monitoring, respiration monitoring, pulmonary diagnostics, blood gas analysis
- **Industrial Applications:** Combustible and toxic gas detection, refrigerant monitoring, flame detection, fruit ripening monitoring, SF₆ monitoring, semiconductor fabrication
- **Automotive:** CO₂ automotive refrigerant monitoring, alcohol detection & interlock, cabin air quality
- Environmental: Heating, ventilating and air conditioning (HVAC), indoor air quality and VOC monitoring, air quality monitoring



■ Features

- · Large modulation depth at high frequencies
- Broad band emission
- Low power consumption
- Long lifetime
- True black body radiation (2 to 14 μm)
- Very fast electrical modulation (no chopper wheel needed)
- Suitable for portable and very small applications
- Rugged MEMS design



■ Absolute Maximum Ratings (T_A = 22°C)

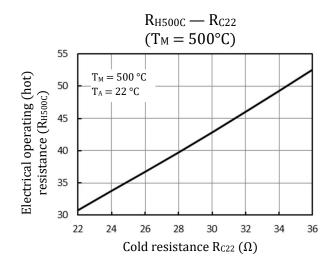
Parameter	Symbol	Rating	Unit
Heater membrane temperature ¹	Тм	500	°C
Optical output power (hemispherical spectral) $(T_M = 500$ °C)	P ₀₀	4.3	mW
Optical output power between 4 μ m and 5 μ m ($T_M = 500$ °C)	P _{s4-5}	0.64	mW
Optical output power between 6 μ m and 8 μ m ($T_M = 500$ °C)	P _{s6-8}	0.83	mW
Optical output power between 8 μ m and 10 μ m ($T_M = 500$ °C)	P _{s9-10}	0.50	mW
Optical output power between 10 μ m and 13 μ m ($T_M = 500$ °C)	P _{s10-13}	0.41	mW
Electrical cold resistance (at $T_M = T_A = 22$ °C)	R _{C22}	22 to 36	Ω
Electrical operating (hot) resistance ² (at $T_M = 500$ °C with $f = \ge 10$ Hz and $t_{on} \ge 3$ ms)	R _{H500C}	1.555 * RC22 - 3.618	Ω
Package temperature	T_{P}	80	°C
Storage temperature	Ts	-20 to +85	°C
Ambient temperature ³ (operation)	T_A	-40 to +125	°C
Heater area	Ан	0.8×0.8	mm ²
Frequency ⁴	f	10 to 100	Hz

Note: Emission power in this table is defined by hemispherical radiation. Stress beyond those listed under "absolute maximum ratings" may cause permanent damage to the device.

Note: Diagram R_{H500C} — R_{C22} \mid (T_M = 500°C)

How to ensure that the maximum temperature for T_M is not exceeded:

- 1. Determine electrical cold resistance R_{C} of the EMIRS device at TA=22 $^{\circ}\text{C}$
- 2. Ensure that anytime R_H does not exceed the representative limit as shown in this diagram with respect to these conditions:
 - a. $f \ge 10 \text{ Hz}$
 - b. on-time (pulse duration) ≥ 3 ms



Electrical operating (hot) resistance R_H versus electrical cold resistance R_{C22} at $T_A = 22^{\circ}C$

 $^{^{\}rm 1}\,\text{Temperatures}$ above 500°C will impact drift and lifetime of the devices.

² See Diagram $R_H - R_C \mid (T_M = 500 \degree C)$

³ The environmental and package temperature might impact the lifetime and characteristic of the devices.

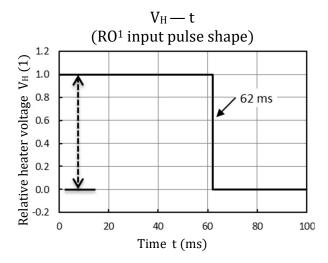
⁴ Lower cut-off frequency of 10 Hz for designed thermodynamic state. DC drive is also possible but recommended with "soft-off" switch.



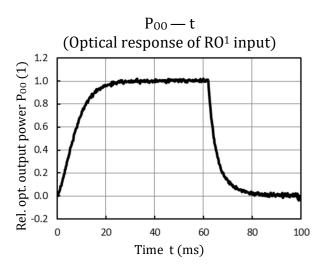
■ Ratings at Reference Operation (RO¹ T_A = 22°C)

Parameter	Symbol	Rating	Unit
Heater membrane temperature	Тм	< 500	°C
Duty cycle of rectangular V _H pulse	D	62	%
Frequency of rect. pulse shape ²	$f_{ m ref}$	10	Hz
On time constant of integral emissive power P ₀₀	$ au_{on}$	10	ms
Off time constant of integral emissive power P ₀₀	$ au_{ m off}$	5	ms
Package temperature at T _A = 22°C	TP	40 to 50	°C

Note: First order on-time model using τ_{on} : First order off-time model using τ_{off} :



Relative rectangular heater voltage (V_H) pulse with a relative pulse width of 62 ms at 10 Hz (time description of reference operation RO^1)



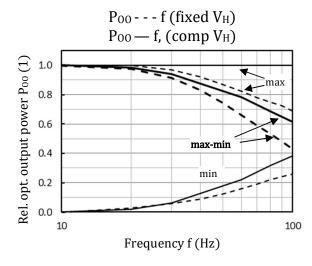
Optical response time (relative optical output power P_{00}) of a rectangular voltage pulse (RO¹ conditions)

¹ Reference Operation: combines lower cut-off frequency of 10 Hz and maximum modulation depth (max-min signal)

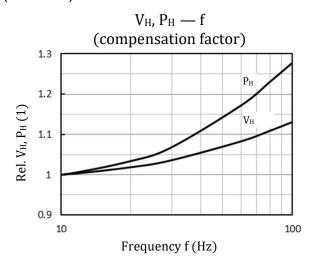
² Recommended frequencies from 10 Hz to 100 Hz



■ Typical Timing Characteristics Frequency (D = 62%)



Relative (to RO) max, min, max-min values of optical output power (P_{00}) versus frequency f with fixed and compensated $V_{\rm H}$



Relative (to RO) electrical drive values heater voltage V_H, power P_H versus frequency f for compensation

Note: Diagrams a, b <u>Relative</u> P_{00} , V_H , P_H to reference operation (RO) f=10 Hz, rect. pulse D=62%

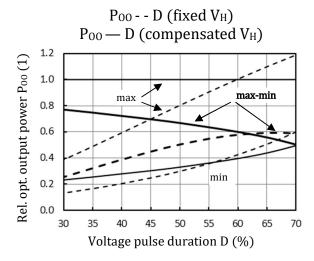
 $\underline{\text{max:}}$ maximum value of P_{00} response shape $\underline{\text{min:}}$ minimum value of P_{00} response shape $\underline{\text{max-min:}}$ amplitude calculation of P_{00} resp. shape

Fixed V_H: same voltage for all frequencies.

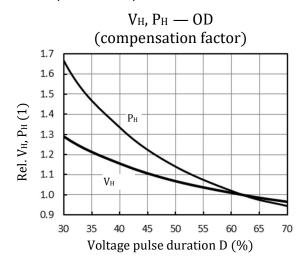
<u>Compensated</u> V_H : for every frequency value, the voltage is adjusted to achieve the same maximum of P_{00} response shape as for 10 Hz.



■ Typical Timing Characteristics Pulse Duration D¹ (f = 100 Hz)



Relative (to D=62%) max, min, max-min values of optical output power (P_{00}) versus duty cycle D with fixed and compensated $V_{\rm H}$



Relative (to RO) electrical drive values heater voltage V_H and power P_H versus duty cycle D for compensation

Note: Diagrams a, b

Relative Poo, VH, PH to reference operation (RO)

f=100 Hz, rect. voltage pulse

 $\underline{\text{max:}}$ maximum value of P_{00} response shape $\underline{\text{min:}}$ minimum value of P_{00} response shape $\underline{\text{max-min:}}$ amplitude calculation of P_{00} resp. shape

Fixed V_H: same voltage for all frequencies.

<u>Compensated</u> V_H : for every frequency value, the voltage is adjusted to achieve the same maximum of P_{00} response shape as for D=62%.

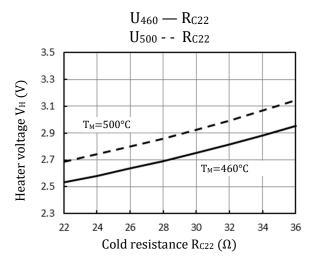
Product Datasheet

¹ Effective D shorter than 30% and voltage or power compensation at high frequencies (e.g. 20% @ 100 Hz) might impact the lifetime and characteristic of the devices because of additional stress in material layers.

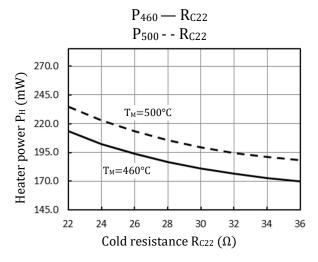


■ Typical Electrical/thermal characteristics (RO, T_A = 22°C)

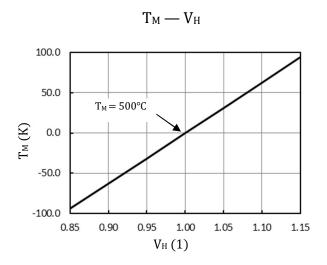
Parameter	Symbol	Rating	Unit
Peak chip membrane temperature	Тм	460	°C
Heater voltage	V_{H}	2.69	V
Heater power	P_{H}	187	mW



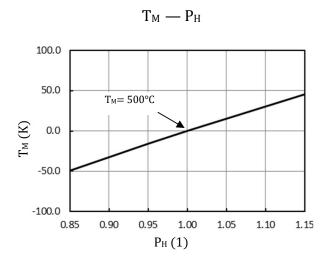
Mean 1 and upper bound of heater voltage V_H vs. cold resistance RC_{22}



Mean 1 and upper bound of heater power P_{H} vs. cold resistance RC_{22}



Relative change of membrane temperature (T_M) by changing heater voltage (V_H)

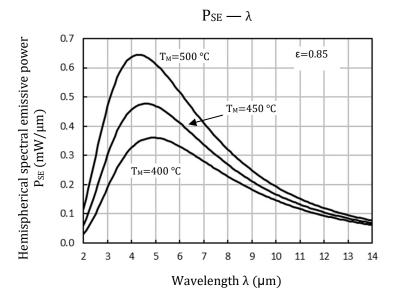


Relative change membrane temperature (T_M) by changing heater power (P_H)

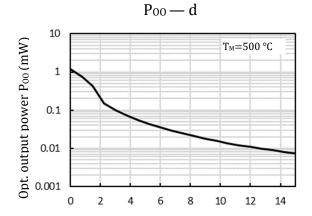
 $^{^1}$ Recommended operation mode T_M =460°C, which ensures 95% confidence that the maximum temperature T_M = 500°C is not exceeded.



■ Typical Optical Characteristics (RO, T_A = 22°C)



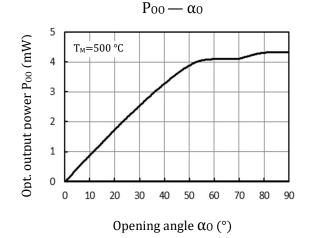
Hemispherical spectral emissive power of EMIRS50 chip surface with a typical emissivity (mean from 2 to 14 $\mu m)$ of $\epsilon{=}0.85$



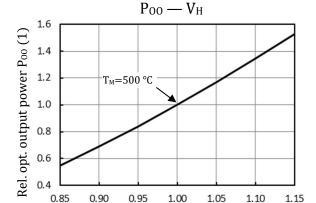
Distance d between EMIRS50 and detector (mm)

Optical output power (P₀₀) versus distance d of a

 $1~mm^2$ detection surface at $500^{\circ}\text{C}~T_\text{M}$

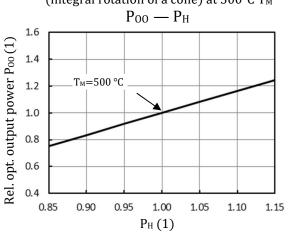


Optical output power (P_{00}) versus opening angle α_0 (integral rotation of a cone) at 500°C T_M



Relative change of optical output power (P₀₀) by changing heater voltage (V_H)

 $V_{H}(1)$



Relative change of optical output power (P_{00}) by changing heater power (P_H)



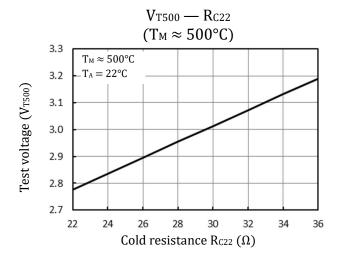
Specified Ratings at Test Voltage V_T (on-time ≥ 20 ms, T_H = T_A = 22°C)

Parameter	Symbol	Condition	Typical value	Unit
Test voltage (for $T_M \approx 500$ °C)	V_{T}	$T_H = T_A = 22$ °C	0.0295 * RC22 + 2.1271	V
Optical output power (after 20 ms on)	P ₀₀	after \geq 20 ms V_T on time, $T_P = T_A = 22$ °C	2.10	mW

Note: Other optical output specifications are possible by customer specific requirements (e.g. spectral ranges).

Note: Diagram V_{T500C} — R_{C22} | $(T_{\text{M}} \approx 500^{\circ}\text{C})$ Defined test voltage V_{T} for specified ratings:

- 1. Determine electrical cold resistance R_{C22} of the EMIRS device at T_A =20°C
- 2. Drive the device with V_T for each R_C as shown in this diagram.
- 3. Ratings are only valid for $T_P = T_A = 22 \,^{\circ}\text{C}$ and after 20 ms on-time.



Test voltage V_T versus electrical cold resistance R_{C22} at $T_A = 22^{\circ}C$